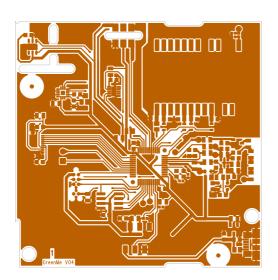


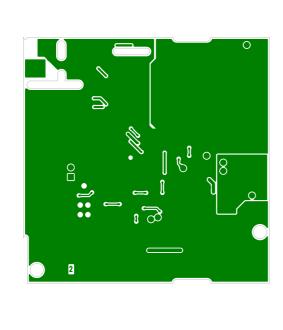
PCB DE	FINITION
Layer count :	2
Board thickness :	1,6mm
Board material :	FR4
Surface :	Copper 35um + Niákel Or
Minimum track width :	>= 0.15mm
Minimum copper gaps :	>= 0.15mm
Minimum drill diameter :	
Solder mask color :	Green
Silkscreen color :	White
	R FILES
Layer1 Top :	X
Layer 2 Bottom :	X
Layer 3 :	
Layer4 :	-
Solder Mask Top :	X
Solder Mask Bottom :	X
Silkscreen Top :	
Silkscreen Bottom :	
Drill drawing :	X
Drill excellon :	X
Paste mask top :	Х
Paste mask bottom :	-
Assembly Top :	-
Assembly Bottom :	_

Désignation : Cube VO4
Volidation : B. Chiron 03/03/2016
ASSEMBLY : TOP



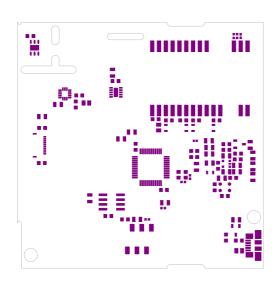
PCB DE	EFINITION
Layer count :	2
Board thickness :	1,6mm
Board material :	FR4
Surface :	Copper 35um + Niåkel Or
Minimum track width :	>= 0.15mm
Minimum copper gaps :	>= 0.15mm
Minimum drill diameter :	>= 0.3mm
Solder mask color :	Green
Silkscreen color :	White
GERBE	R FILES
Layer 2 Bottom :	X
Layer 3 :	
Layer4:	
Solder Mask Top :	Х
Solder Mask Bottom :	X
Silkscreen Top :	_
Silkscreen Bottom :	_
Drill drawing :	χ
Drill excellon :	X
Paste mask top :	X
Paste mask bottom :	_
Assembly Top :	_
Assembly Bottom :	-

Désignation :	Cube V04	
Validation :	B. Chiron	03/03/2016
LAYER 1 : TO	P	·

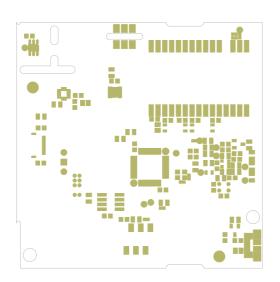


PCB D	EFINITION
Layer count :	2
Board thickness :	1,6mm
Board material :	FR4
Surface :	Copper 35um + Niákel Or
Minimum track width :	>= 0.15mm
Minimum copper gaps :	>= 0.15mm
Minimum drill diameter	; >= 0.3mm
Solder mask color :	Green
Silkscreen color :	White
GERBE Layer1 Top :	ER FILES X
Layer 2 Bottom :	X
Layer 3:	_
Layer4 :	_
Solder Mask Top :	Χ
Solder Mask Bottom :	Χ
Silkscreen Top :	-
Silkscreen Bottom :	-
Drill drawing :	Χ
Drill excellon :	Χ
Paste mask top :	Х
Paste mask bottom :	-
Assembly Top :	-
Assembly Bottom :	

Désignation :	Cube V04	
Validation :	B. Chiron	03/03/2016
LAYER 2 · B	OTTOM	



PCB DE	FINITION
Layer count :	2
Board thickness :	1,6mm
Board material :	FR4
Surface :	Copper 35um + Niåkel Or
Minimum track width :	>= 0.15mm
Minimum copper gaps :	>= 0.15mm
Minimum drill diameter :	
Solder mask color :	Green
Silkscreen color :	White
	R FILES
Layer1 Top :	X
Layer 2 Bottom :	Х
Layer 3 :	-
Layer4 :	
Solder Mask Top :	Х
Solder Mask Bottom :	Х
Silkscreen Top :	
Silkscreen Bottom :	
Drill drawing :	Χ
Drill excellon :	Χ
Paste mask top :	Χ
Paste mask bottom :	-
Assembly Top :	-
Assembly Bottom :	



PCB DE	FINITION
Layer count :	2
Board thickness :	1,6mm
Board material :	FR4
Surface :	Copper 35um + Niåkuel Or
Minimum track width :	>= 0.15mm
Minimum copper gaps :	>= 0.15mm
Minimum drill diameter :	
Solder mask color :	Green
Silkscreen color :	White
	R FILES
Layer1 Top :	X
Layer 2 Bottom :	
Layer 3:	
Layer4:	
Solder Mask Top :	X
Solder Mask Bottom :	Λ
Silkscreen Top :	
Silkscreen Bottom :	
Drill drawing :	X
Drill excellon :	X
Paste mask top :	X
Paste mask bottom :	
Assembly Top :	_
Assembly Bottom :	_

Désignation : Cube VO4
Validation : B. Chiron 03/03/2016
Solder Mask Top

PCB DE	FINITION	
Layer count :	2	
Board thickness :	1,6mm	
Board material :	FR4	
Surface :	Copper 35um + Niåkel Or	
Minimum track width :	>= 0.15mm	
Minimum copper gaps :	>= 0.15mm	
Minimum drill diameter :	>= 0.3mm	
Solder mask color :	Green	
Silkscreen color :	White	
GERBER FILES		
Layer1 Top :	Х	
Layer 2 Bottom :	X	
Layer 3 :		
Layer4 :	_	
Solder Mask Top :	X	
Solder Mask Bottom :	Χ	
Silkscreen Top :	-	
Silkscreen Bottom :		
Drill drawing :	Χ	
Drill excellon :	Χ	
Paste mask top :	Χ	
Paste mask bottom :	-	
Assembly Top :	-	
Assembly Bottom :		

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Désignation :	Cube VO4	
Validation :	B. Chiron	03/03/2016
SOLDER MASK	ROTTOM	